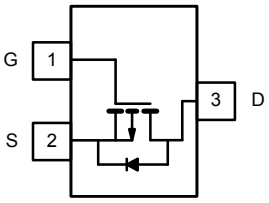
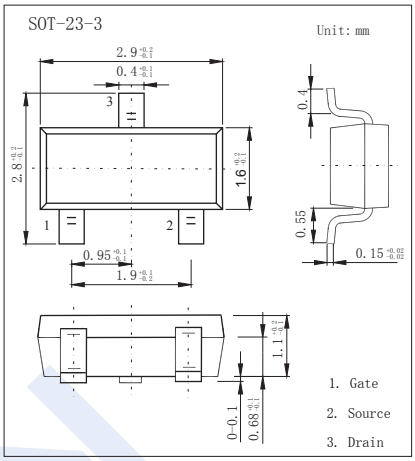
P-Channel Enhancement MOSFET

SI2303 (KI2303)

■ Features

- $V_{DS\ (V)}$ =-30V
- $R_{DS(ON)}$ < 200mΩ (V_{GS} =-10V)
- $R_{DS(ON)}$ < 380mΩ (V_{GS} =-4.5V)





■ Absolute Maximum Ratings Ta = 25℃

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	±20	
Continuous Drain Current (TJ =150℃) *1 Ta = 25℃	I_D	-1.7	A
Ta = 70℃		-1.4	
Pulsed Drain Current	I_{DM}	-10	
Power Dissipation Ta = 25℃	P_D	1.25	W
Ta = 70℃		0.8	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	100	℃/W
(surface mounted on FR4 board)		166	
Junction Temperature	T_J	150	℃
Storage Temperature Range	T_{stg}	-55 to 150	

*1 Surface Mounted on 1" x 1" FR4 Board.

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■ Electrical Characteristics Ta = 25℃

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V_{DSS}	I_D=-250μA, V_{GS}=0V	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V			-1	μA
		V_{DS}=-30V, V_{GS}=0V, T_J=55℃			-10	
Gate-Body leakage current	I_{GSS}	V_{DS}=0V, V_{GS}=±20V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS} I_D=-250μA	-1.0		-3.0	V
Static Drain-Source On-Resistance *1	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-1.7A			200	mΩ
		V_{GS}=-4.5V, I_D=-1.3A			380	
On state drain current *1	$I_{D(ON)}$	V_{GS}=-10V, V_{DS}≥-5V	-6			A
Forward Transconductance *1	g_{FS}	V_{DS}=-10V, I_D=-1.7A		2.4		S
Input Capacitance *2	C_{iss}	V_{GS}=0V, V_{DS}=-15V, f=1MHz		226		pF
Output Capacitance *2	C_{oss}			87		
Reverse Transfer Capacitance *2	C_{rss}			19		
Total Gate Charge *2	Q_g	V_{GS}=-10V, V_{DS}=-4.5V, I_D=-1.7A		5.8	10	nC
Gate Source Charge *2	Q_{gs}			0.8		
Gate Drain Charge *2	Q_{gd}			1.5		
Turn-On DelayTime *3	$t_{d(on)}$	V_{GS}=-10V, V_{DS}=-15V, R_L=15Ω, R_{GEN}=6Ω I_D=-1.0A		9.0	20	ns
Turn-On Rise Time *3	t_r			9.0	20	
Turn-Off DelayTime *3	$t_{d(off)}$			18	35	
Turn-Off Fall Time *3	t_f			6.0	20	
Maximum Body-Diode Continuous Current	I_S				-1.25	A
Diode Forward Voltage	V_{SD}	I_S=-1.25A,V_{GS}=0V		-0.8	-1.2	V

*1 Pulse test: PW ≤ 300us duty cycle≤ 2%.

*2 For DESIGN AID ONLY, not subject to production testing.

*3 Switching time is essentially independent of operating temperature.

■ Marking

Marking	A3*

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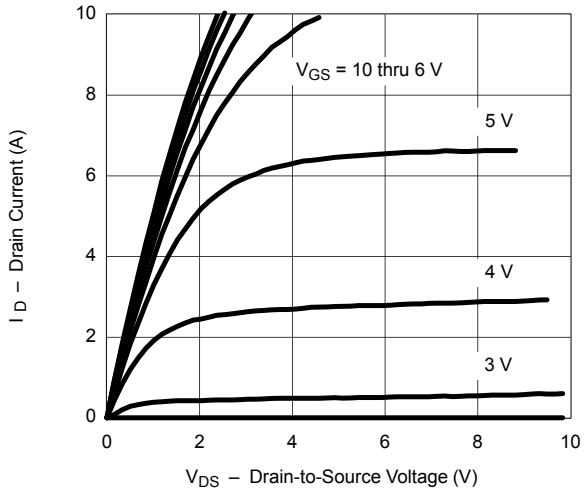
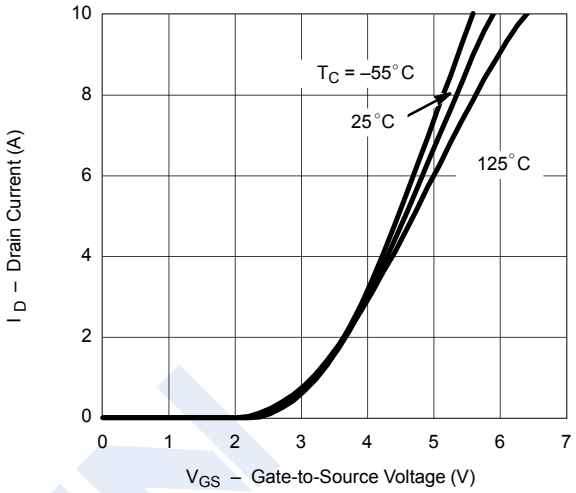
■ Typical Characterisitics

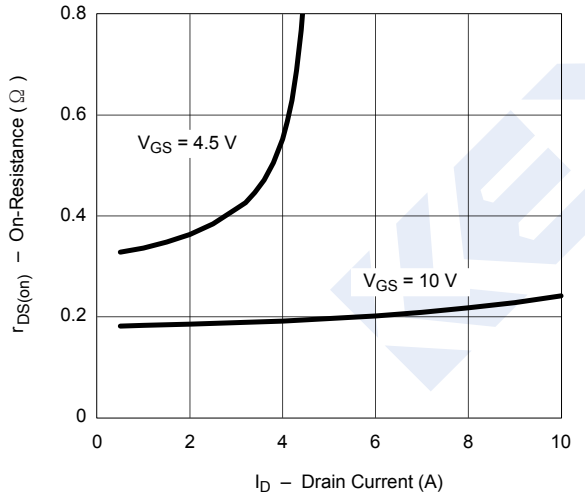
Output Characteristics



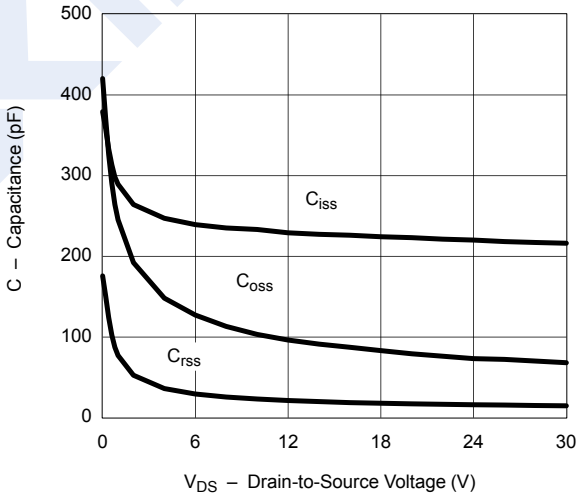
Transfer Characteristics



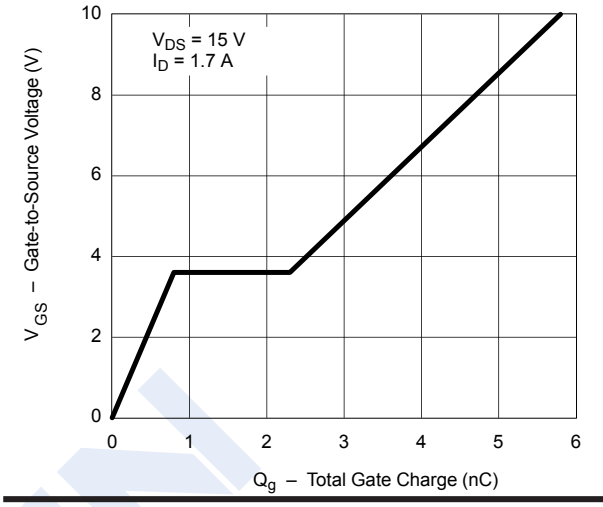
On-Resistance vs. Drain Current



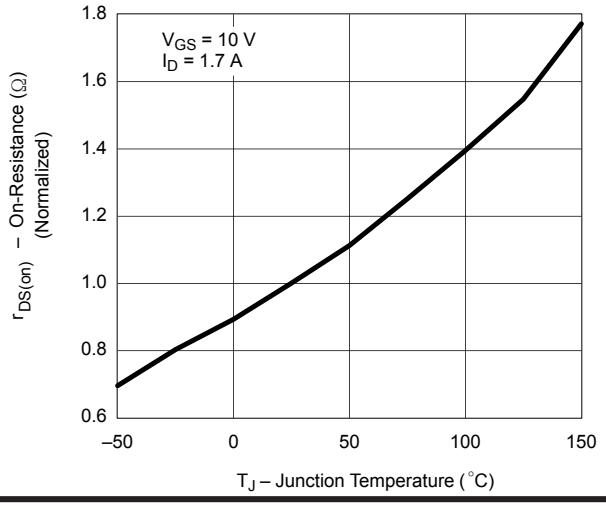
Capacitance



Gate Charge



On-Resistance vs. Junction Temperature



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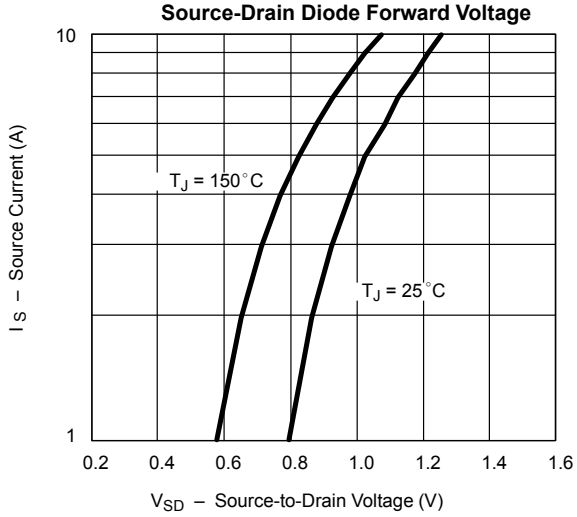
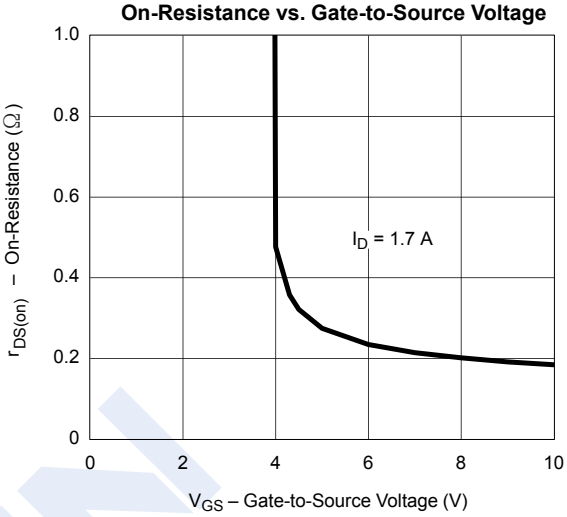
■ Typical Characterisitics

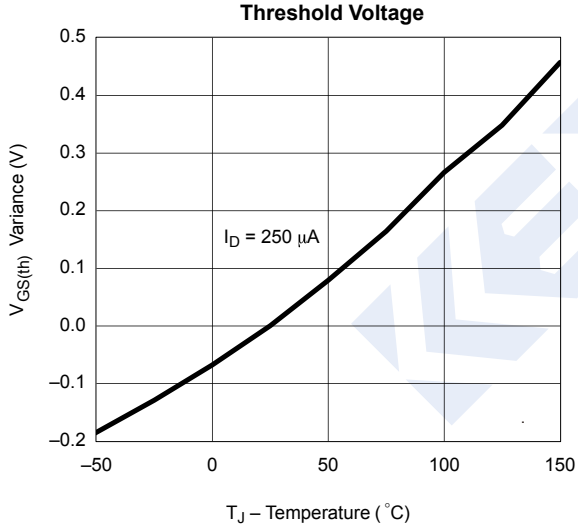
Source-Drain Diode Forward Voltage



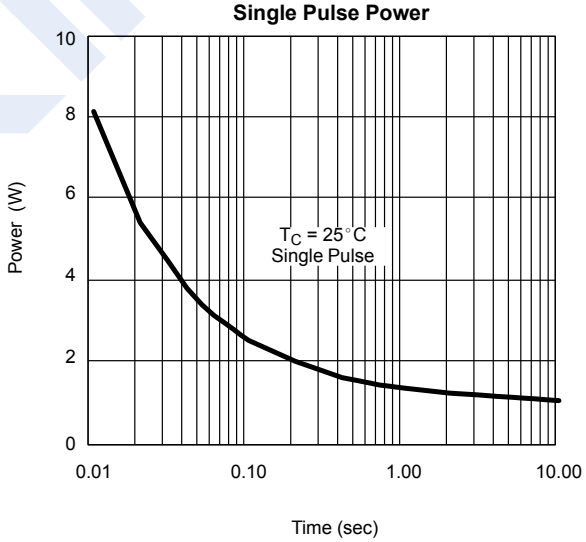
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient